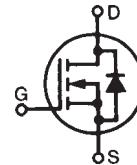


Polar™ Power MOSFET
(Electrically Isolated Tab)

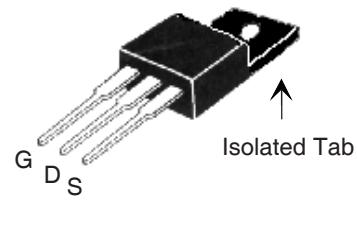
IXTA7N60PM
IXTP7N60PM

V_{DSS} = 600V
I_{D25} = 4A
R_{DS(on)} ≤ 1.1Ω



N-Channel Enhancement Mode
Avalanche Rated
Fast Intrinsic Diode

**OVERMOLDED TO-220
(IXTP...M) OUTLINE**



G = Gate D = Drain
S = Source

Symbol	Test Conditions	Maximum Ratings		
V _{DSS}	T _J = 25°C to 150°C	600	V	
V _{DGR}	T _J = 25°C to 150°C, R _{GS} = 1 MΩ	600	V	
V _{GSS}	Continuous	± 30	V	
V _{GSM}	Transient	± 40	V	
I _{D25}	T _C = 25°C	4	A	
I _{DM}	T _C = 25°C, pulse width limited by T _{JM}	14	A	
I _A	T _C = 25°C	7	A	
E _{AS}	T _C = 25°C	400	mJ	
dv/dt	I _S ≤ I _{DM} , V _{DD} ≤ V _{DSS} , T _J = 150°C	10	V/ns	
P _D	T _C = 25°C	41	W	
T _J		- 55 ... +150	°C	
T _{JM}		150	°C	
T _{stg}		- 55 ... +150	°C	
T _L	1.6 mm (0.062 in.) from case for 10 s	300	°C	
T _{SOLD}	Plastic body for 10 s	260	°C	
M _d	Mounting torque	1.13/10	Nm/lb.in.	
Weight		2.5	g	

Symbol	Test Conditions (T _J = 25°C, unless otherwise specified)	Characteristic Values		
		Min.	Typ.	Max.
BV _{DSS}	V _{GS} = 0V, I _D = 250µA	600		V
V _{GS(th)}	V _{DS} = V _{GS} , I _D = 100µA	3.0		5.5 V
I _{GSS}	V _{GS} = ±30V, V _{DS} = 0V			±100 nA
I _{DSS}	V _{DS} = V _{DSS} V _{GS} = 0V			5 µA 50 µA
R _{DS(on)}	V _{GS} = 10V, I _D = 3.5A, Note 1			1.1 Ω

Features

- Plastic overmolded tab for electrical isolation
- International standard package
- Avalanche rated
- Low package inductance
 - easy to drive and to protect

Advantages

- Easy to mount
- Space savings

Applications

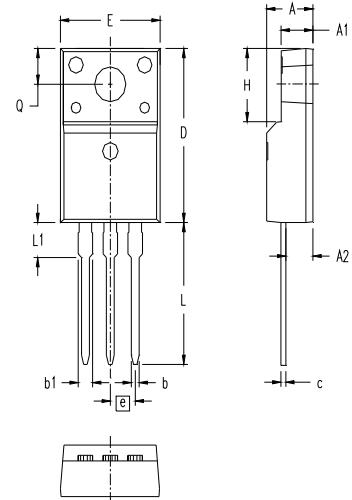
- DC-DC converters
- Battery chargers
- Switched-mode and resonant-mode power supplies
- DC choppers
- AC motor drives
- Uninterruptible power supplies
- High speed power switching applications

Symbol	Test Conditions	Characteristic Values		
		($T_J = 25^\circ\text{C}$, unless otherwise specified)	Min.	Typ.
g_{fs}	$V_{DS} = 10\text{V}, I_D = 3.5\text{A}$, Note 1	4	7	S
C_{iss} C_{oss} C_{rss}	$V_{GS} = 0\text{V}, V_{DS} = 25\text{V}, f = 1\text{MHz}$	1180		pF
		110		pF
		11		pF
$t_{d(on)}$ t_r $t_{d(off)}$ t_f	Resistive Swithcing Times $V_{GS} = 10\text{V}, V_{DS} = 0.5 \cdot V_{DSS}, I_D = 7\text{A}$ $R_G = 18\Omega$ (External)	20		ns
		27		ns
		65		ns
		26		ns
$Q_{g(on)}$ Q_{gs} Q_{gd}	$V_{GS} = 10\text{V}, V_{DS} = 0.5 \cdot V_{DSS}, I_D = 3.5\text{A}$	20		nC
		7		nC
		7		nC
R_{thJC}			3.0	$^\circ\text{C}/\text{W}$

Source-Drain Diode
Characteristic Values
 $(T_J = 25^\circ\text{C}$ unless otherwise specified)

Symbol	Test Conditions	Min.	Typ.	Max.
I_s	$V_{GS} = 0\text{V}$		7	A
I_{SM}	Repetitive, pulse width limited by T_{JM}		28	A
V_{SD}	$I_F = I_S, V_{GS} = 0\text{V}$, Note 1		1.5	V
t_{rr}	$I_F = 7\text{A}, -di/dt = 100\text{A}/\mu\text{s}$, $V_R = 100\text{V}, V_{GS} = 0\text{V}$	500		ns

Notes:1. Pulse test, $t \leq 300 \mu\text{s}$; duty cycle, $d \leq 2 \%$.

ISOLATED TO-220 (IXTP...M)

Terminals:
1 - Gate
2 - Drain (Collector)
3 - Source (Emitter)

SYM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	.177	.193	4.50	4.90
A1	.092	.108	2.34	2.74
A2	.101	.117	2.56	2.96
b	.028	.035	0.70	0.90
b1	.050	.058	1.27	1.47
c	.018	.024	0.45	0.60
D	.617	.633	15.67	16.07
E	.392	.408	9.96	10.36
e	.100	BSC	2.54	BSC
H	.255	.271	6.48	6.88
L	.499	.523	12.68	13.28
L1	.119	.135	3.03	3.43
$\emptyset P$.121	.129	3.08	3.28
Q	.126	.134	3.20	3.40

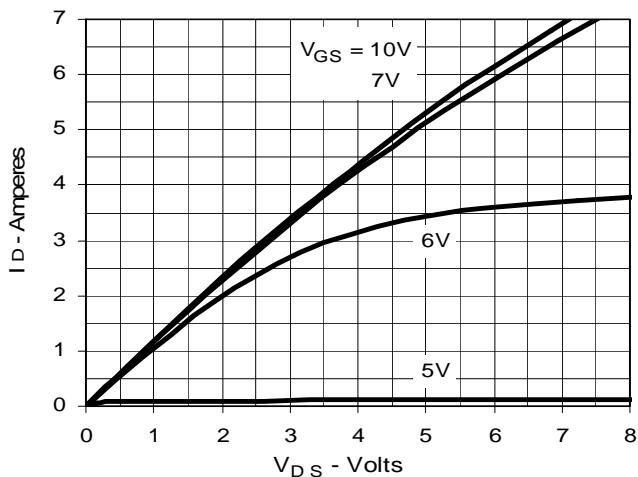
PRELIMINARY TECHNICAL INFORMATION

The product presented herein is under development. The Technical Specifications offered are derived from data gathered during objective characterizations of preliminary engineering lots; but also may yet contain some information supplied during a pre-production design evaluation. IXYS reserves the right to change limits, test conditions, and dimensions without notice.

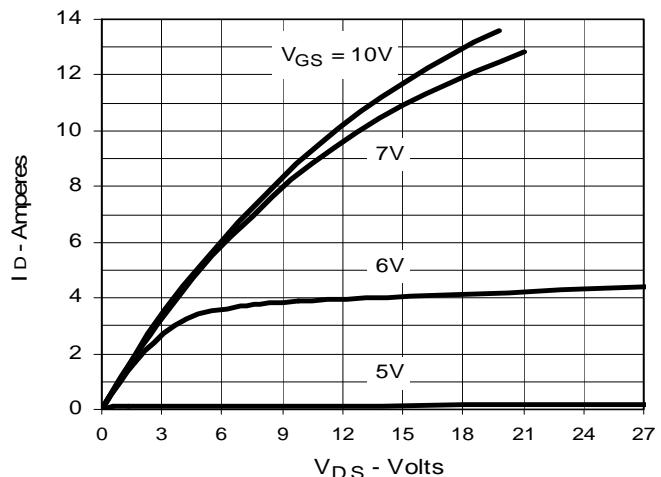
IXYS reserves the right to change limits, test conditions, and dimensions.

IXYS MOSFETs and IGBTs are covered by one or more of the following U.S. patents: 4,835,592 4,931,844 5,049,961 5,237,481 6,162,665 6,404,065 B1 6,683,344 6,727,585 7,005,734 B2 7,157,338B2 4,850,072 5,017,508 5,063,307 5,381,025 6,259,123 B1 6,534,343 6,710,405 B2 6,759,692 7,063,975 B2 4,881,106 5,034,796 5,187,117 5,486,715 6,306,728 B1 6,583,505 6,710,463 6,771,478 B2 7,071,537

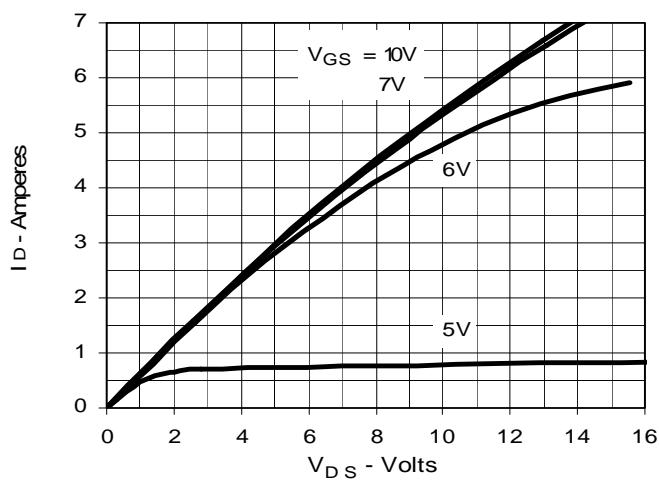
**Fig. 1. Output Characteristics
@ 25°C**



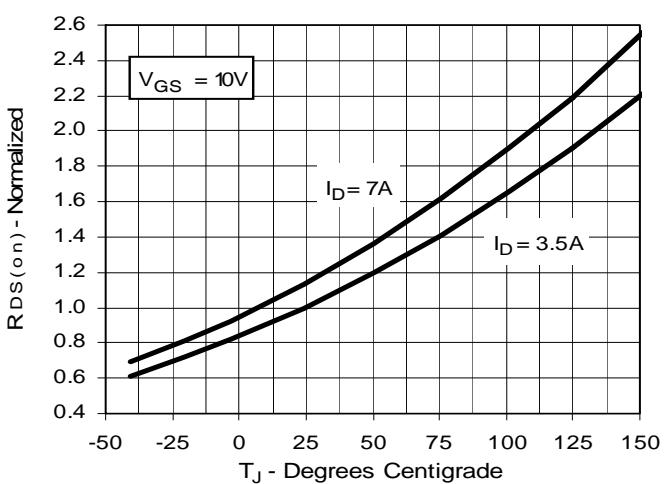
**Fig. 2. Extended Output Characteristics
@ 25°C**



**Fig. 3. Output Characteristics
@ 125°C**



**Fig. 4. $R_{DS(on)}$ Normalized to 0.5 I_{D25} Value
vs. Junction Temperature**



**Fig. 5. $R_{DS(on)}$ Normalized to 0.5 I_{D25} Value
vs. I_D**

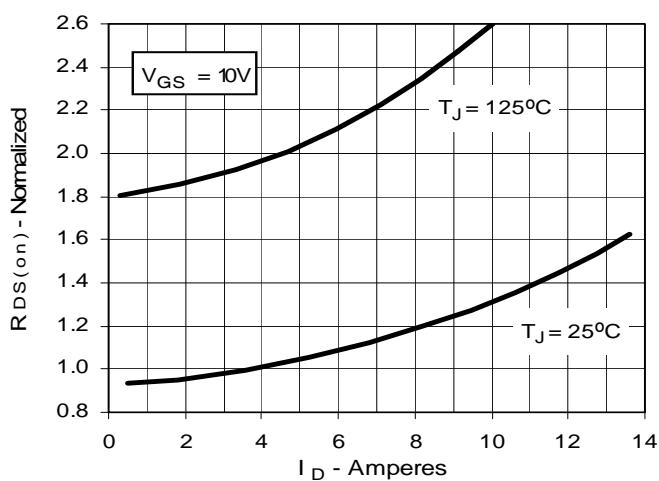


Fig. 6. Drain Current vs. Case Temperature

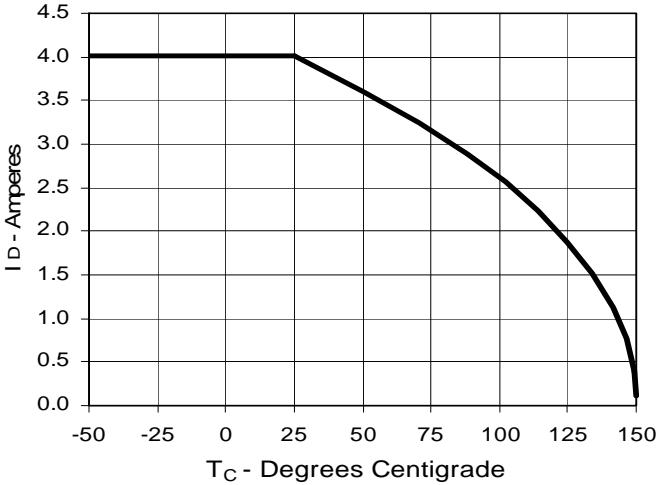
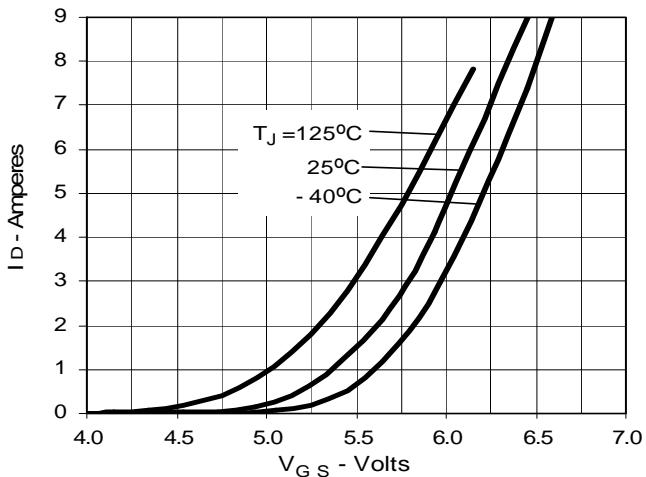
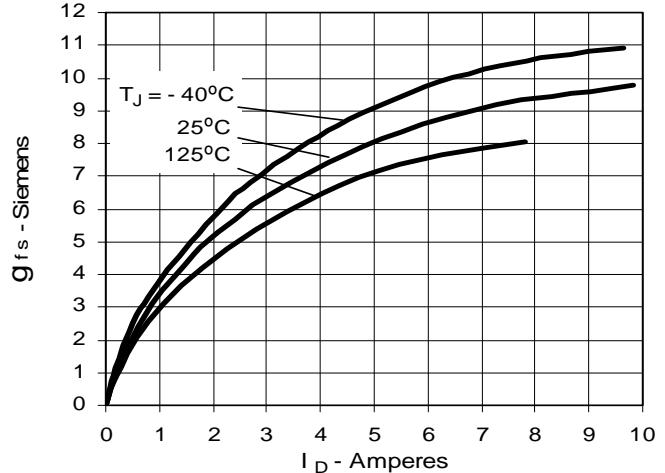
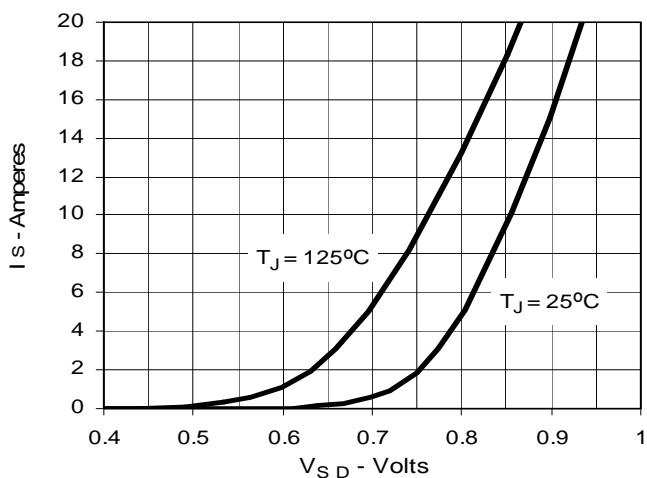
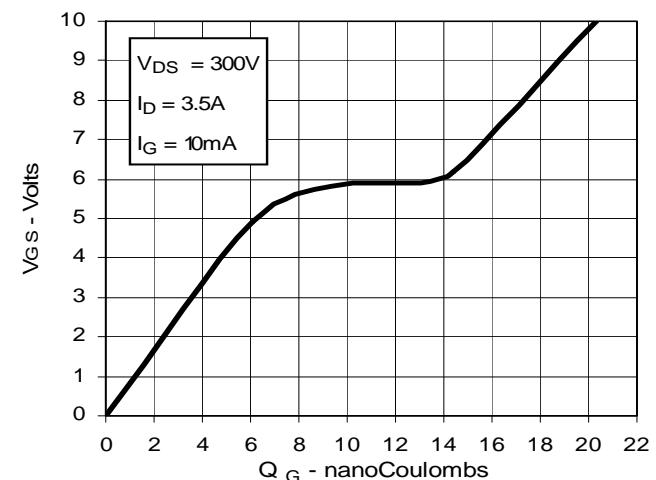
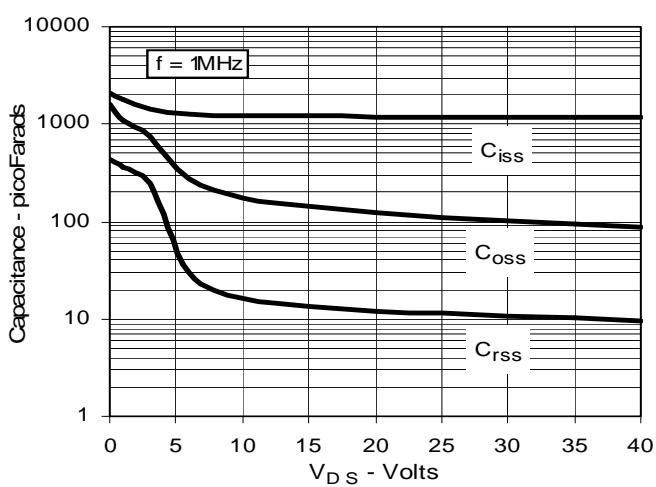
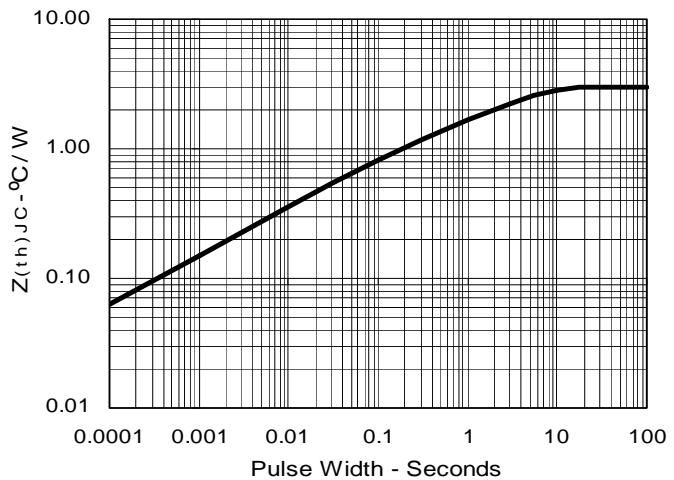


Fig. 7. Input Admittance

Fig. 8. Transconductance

Fig. 9. Source Current vs. Source-To-Drain Voltage

Fig. 10. Gate Charge

Fig. 11. Capacitance

Fig. 12. Maximum Transient Thermal Impedance


X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for [MOSFET](#) category:

Click to view products by [IXYS](#) manufacturer:

Other Similar products are found below :

[614233C](#) [648584F](#) [IRFD120](#) [JANTX2N5237](#) [FCA20N60_F109](#) [FDZ595PZ](#) [2SK2545\(Q,T\)](#) [405094E](#) [423220D](#) [TPCC8103,L1Q\(CM](#)
[MIC4420CM-TR](#) [VN1206L](#) [614234A](#) [715780A](#) [NTNS3166NZT5G](#) [SSM6J414TU,LF\(T](#) [751625C](#) [BUK954R8-60E](#) [NTE6400](#) [SQJ402EP-](#)
[T1-GE3](#) [2SK2614\(TE16L1,Q\)](#) [2N7002KW-FAI](#) [DMN1017UCP3-7](#) [EFC2J004NUZTDG](#) [ECH8691-TL-W](#) [FCAB21350L1](#) [P85W28HP2F-](#)
[7071](#) [DMN1053UCP4-7](#) [NTE221](#) [NTE222](#) [NTE2384](#) [NTE2903](#) [NTE2941](#) [NTE2945](#) [NTE2946](#) [NTE2960](#) [NTE2967](#) [NTE2969](#) [NTE2976](#)
[NTE6400A](#) [NTE2910](#) [NTE2916](#) [NTE2956](#) [NTE2911](#) [DMN2080UCB4-7](#) [TK10A80W,S4X\(S](#) [SSM6P69NU,LF](#) [DMP22D4UFO-7B](#)
[DMN1006UCA6-7](#) [DMN16M9UCA6-7](#)